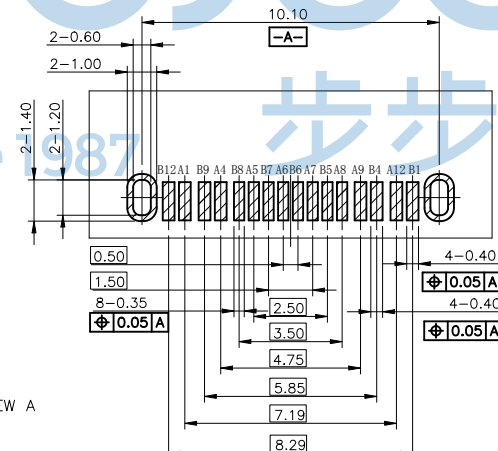
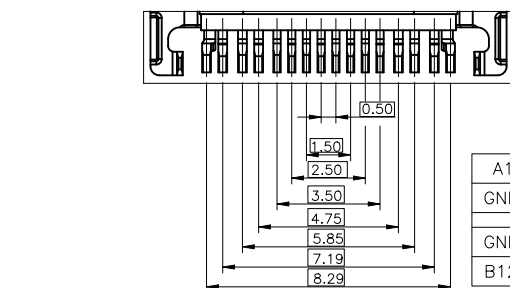
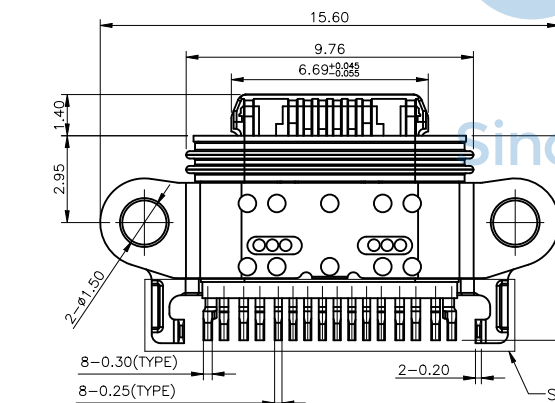
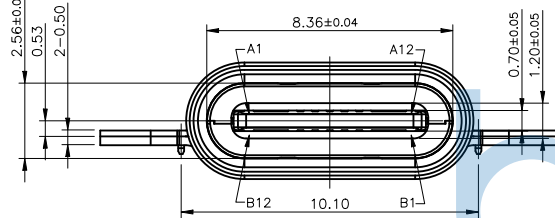
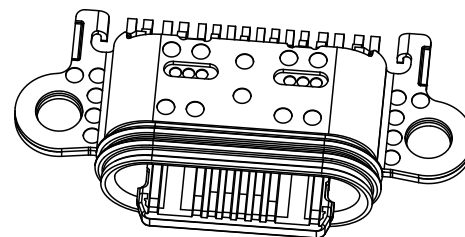
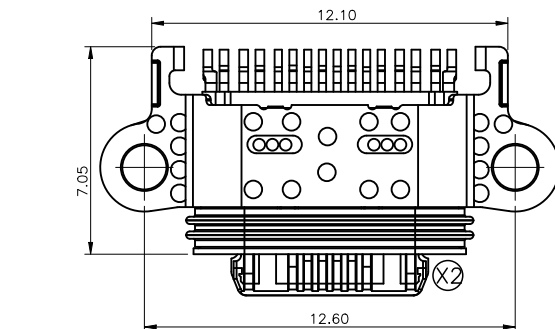


REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

NOTES:

1. CURRENT RATING: 8A MAX. ;
2. DIELECTRIC WITHSTANDING: 100V AC MIN. ;
3. TEMPERATURE RANGE: -30° C~85° C;
4. CONTACT RESISTANCE: 40mΩ MAX. ;
5. INSULATION RESISTANCE: 100MΩ MIN. ;
6. DURABILITY: 10,000 CYCLES MIN. ;
7. INSERTION FORCE: 5N~20N;
8. EXTRACTION FORCE:
 - (1) INITIAL: 8N~20N;
 - (2) AFTER DURABILITY: 6N~20N.
9. PRODUCT MEET THE REQUEST OF THE RoHS.



RECOMMENDED PCB LAYOUT(T=0.80)
SCALE: 2:1(GENERAL TOLERANCE±0.05)

A1			A4	A5	A6	A7	A8	A9	A10	A11	A12
GND	TX1+	TX1-	VBUS	CC1	D+	D-	SBU1	VBUS	RX2-	RX2+	GND
GND	RX1+	RX1-	VBUS	SBU2	D-	D+	CC2	VBUS	TX2-	TX2+	GND
B12	B11	B10	B9	B8	B7	B6	B5	B4			B1

PIN ASSIGNMENT
(FRONT VIEW)

11	MAIN HOUSING	1 PCS	HIGH TEMPERATURE PLASTIC	BLACK
10	TOP HOUSING	1 PCS	HIGH TEMPERATURE PLASTIC	BLACK
09	BOTTOM HOUSING	1 PCS	HIGH TEMPERATURE PLASTIC	BLACK
08	RUBBER	1 PCS	LSR	BLACK
07	LOW SHELL	1 PCS	STAINLESS STEEL	SOLDER:NI PLATED
06	UPPER SHELL	1 PCS	STAINLESS STEEL	SOLDER:AU GOLD FLASH/NI PLATED
05	INNER SHELL	1 PCS	STAINLESS STEEL	SOLDER:NI PLATED
04	SOLDERING PART	1 PCS	STAINLESS STEEL	SOLDER:NI PLATED
03	PLATE	1 PCS	STAINLESS STEEL	NO PLATING
02	CONTACT B	1 SET	COPPER ALLOY	AU:SEE TABLE A/NI PLATED
01	CONTACT A	1 SET	COPPER ALLOY	AU:SEE TABLE A/NI PLATED
ITEM	PART NAME	Q'TY	MATERIAL	DESCRIPTION

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PDWG.NO: 0523-1



深圳市步步精科技有限公司

.X: ±0.38
.XX: ±0.25
.XXX: ±0.13

NAME:TYPE-C 16P 防水母座 沉板1.0 L=7.05 CH=0.78
舌片外漏1.40 带双耳螺丝孔 端子SMT IP68

APPD. JM_Zheng

CHKD. LYX

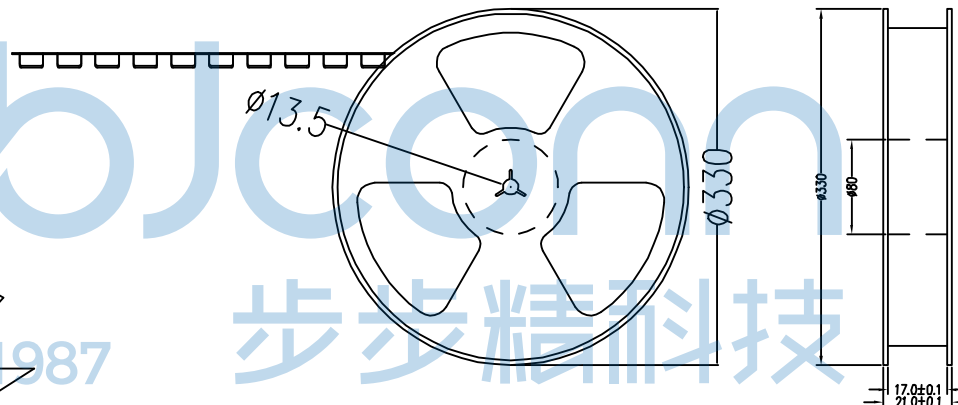
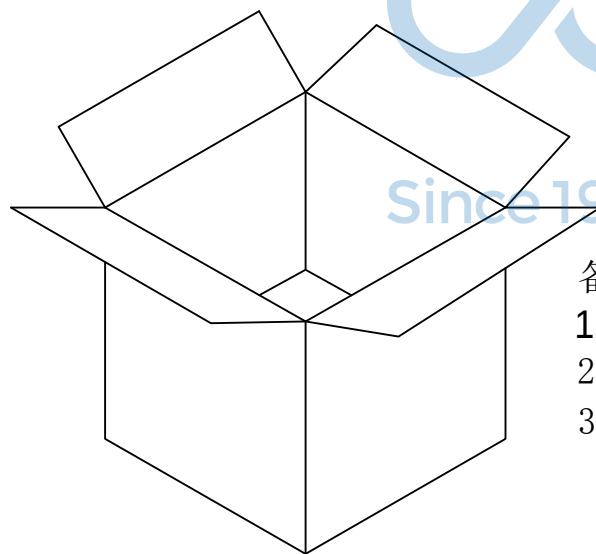
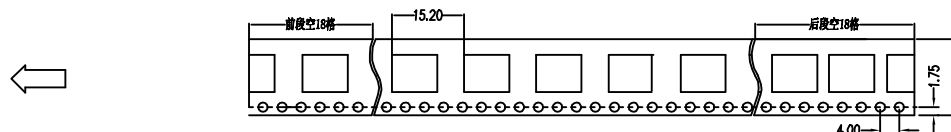
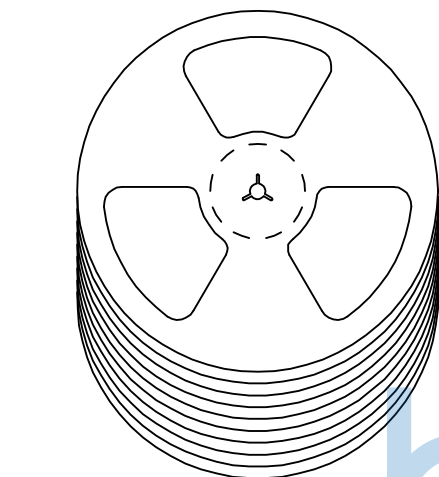
DR. TSP

PJ. NO.: UC.01.31-1W-0007

SIZE: A4 DRW NO.:

FINISH: SEE NOTES MAT'L.: SEE NOTES

SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/2



备注:

1. 包装数量：1200/PCS/卷，10卷/箱
2. 包装袋长度：每卷前后各空10-20个空格，中间包装。
3. 材质：
载体：聚丙烯（PS），
上带：聚乙烯（PET），
卷盘：聚苯乙烯。

纸箱规格：345*345*23MM

纸箱规格：345*345*35MM

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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		X': ±3" .X': ±2" .XX': ±1"		PJ. NO.: UC.01.31-1W-0007	
APPD. JM_Zheng		CHKD. LYX		SIZE: A4 DRW NO.:	
PDWG.NO: 0523-1		DR. TSP		FINISH: SEE NOTES MAT'L.: SEE NOTES	
				SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/2	